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LED Display

Product Data Sheet

LTS-4817CTB-P

Spec No.: DS30-2011-0114

Effective Date: 12/01/2011

Revision: -

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

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LED DISPLAY**LTS-4817CTB-P**
DATA SHEET

<u>ITEM</u>	<u>Description</u>	<u>By</u>	<u>DATE</u>
1	New Spec	Eason Lin	2010/09/23
2	2.1 Modify packing dimensions. 2.2 Modify recommended soldering condition patterns.	Reo Lin	2011/09/21

FEATURES

- * 0.39 inch (10.0 mm) DIGIT HEIGHT
- * CONTINUOUS UNIFORM SEGMENTS
- * LOW POWER REQUIREMENT
- * EXCELLENT CHARACTERS APPEARANCE
- * HIGH BRIGHTNESS & HIGH CONTRAST
- * WIDE VIEWING ANGLE
- * SOLID STATE RELIABILITY
- * CATEGORIZED FOR LUMINOUS INTENSITY
- * SMD DISPLAY
- * **LEAD FREE PACKAGE (ACCORDING TO ROHS)**

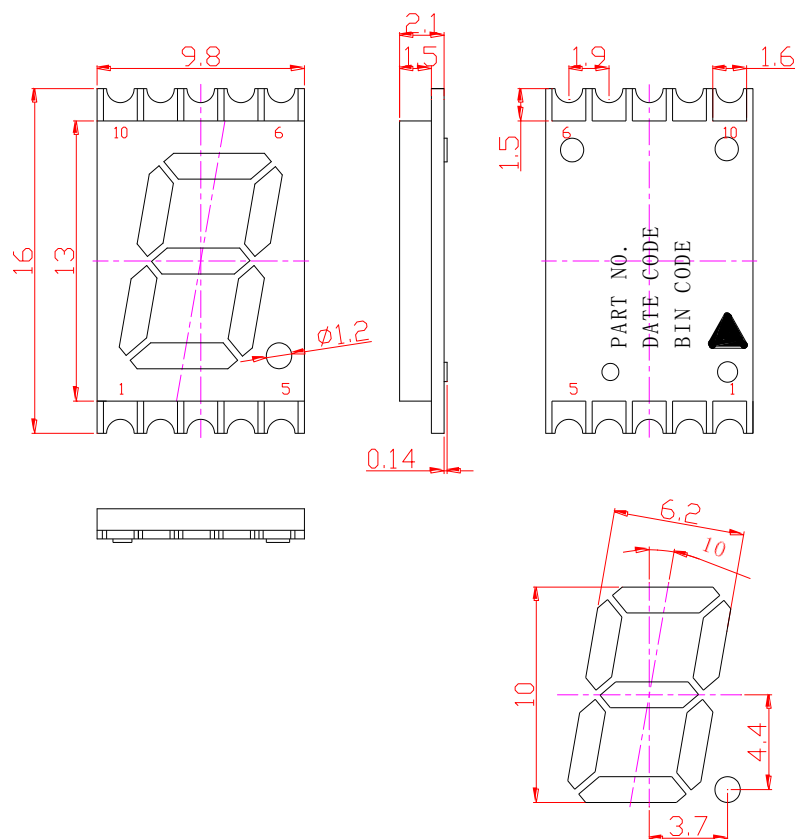
DESCRIPTION

The LTS-4817CTB-P is a 0.39 inch (10.0 mm) digit height single digit SMD display. This device uses InGaN blue LED chips (InGaN epi on Sapphire substrate). The display has gray face and white segments, and suitable for reverse mount assembly.

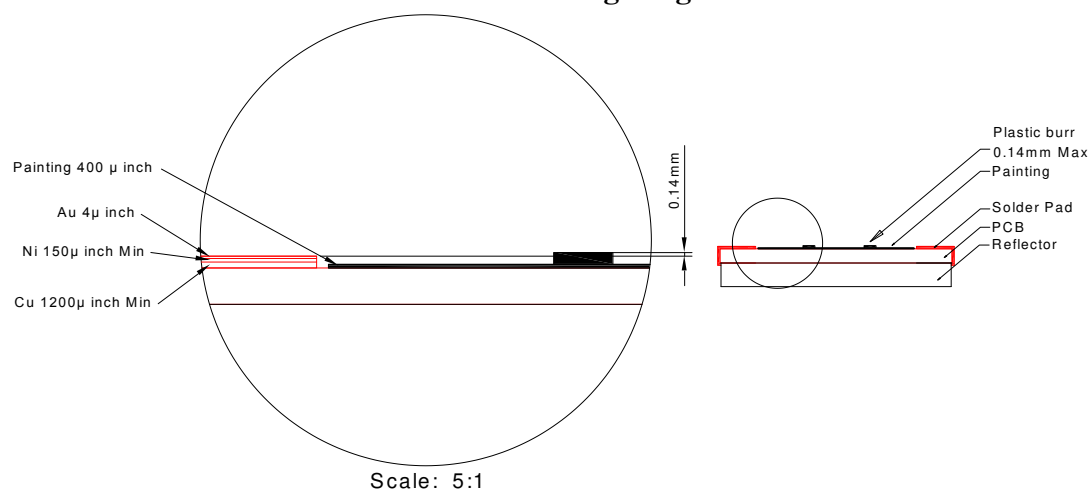
DEVICE

PART NO.	DESCRIPTION
InGaN Blue	Common Anode
LTS-4817CTB-P	

PACKAGE DIMENSIONS



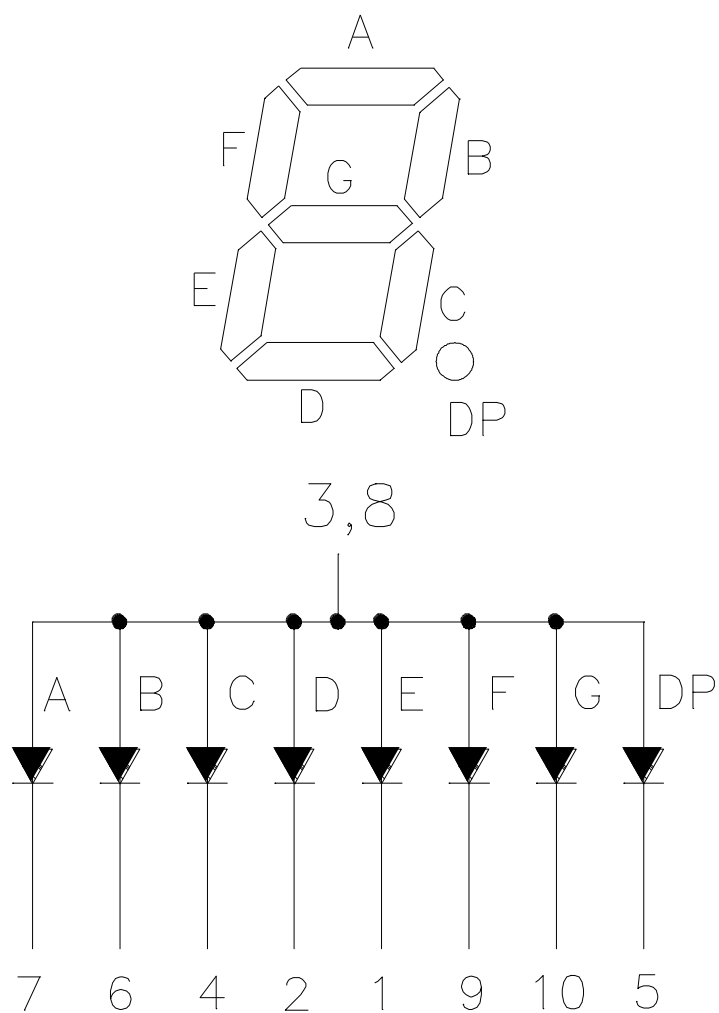
Solder Pad Vs Painting Diagram



NOTES:

1. Plastic pins' burr max. 0.14 mm,
2. All dimensions are in millimeters. Tolerances are $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.
3. Solder pad materials and thickness: Cu: $1200\ \mu$ inch Ni: Min $150\ \mu$ inch Au: $4\ \mu$ inch.

INTERNAL CIRCUIT DIAGRAM



PIN CONNECTION

No.	CONNECTION
1	CATHODE E
2	CATHODE D
3	COMMON ANODE
4	CATHODE C
5	CATHODE D.P.
6	CATHODE B
7	CATHODE A
8	COMMON ANODE
9	CATHODE F
10	CATHODE G

ABSOLUTE MAXIMUM RATING AT Ta = 25°C

PARAMETER	MAXIMUM RATING	UNIT
Power Dissipation Per Segment	70	mW
Peak Forward Current Per Segment (Frequency 1Khz,10% duty cycle)	100	mA
Continuous Forward Current Per Segment	20	mA
Forward Current Derating from 25 °C	0.21	mA/°C
Operating Temperature Range	-40 °C to +105 °C	
Storage Temperature Range	-40 °C to +105 °C	
Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260 °C		

ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Average Luminous Intensity	Iv	8.4	26.8		mcd	IF =10mA
Peak Emission Wavelength	λp		468		nm	IF=20mA
Spectral Line Half-Width	Δλ		25		nm	IF=20mA
Dominant Wavelength	λd		470		nm	IF=20mA
Forward Voltage Per Segment	VF		3.3	3.6	V	IF=20mA
Reverse Current Per Segment ⁽²⁾	IR			100	uA	VR=5V
Luminous Intensity Matching Ratio	Iv-m			2:1		IF=10mA

Note:

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commision Internationale De L'Eclairage) eye-response curve.
- Reverse voltage is only for IR test. It can not continue to operate at this situation.

TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES

(25°C Ambient Temperature Unless Otherwise Noted)

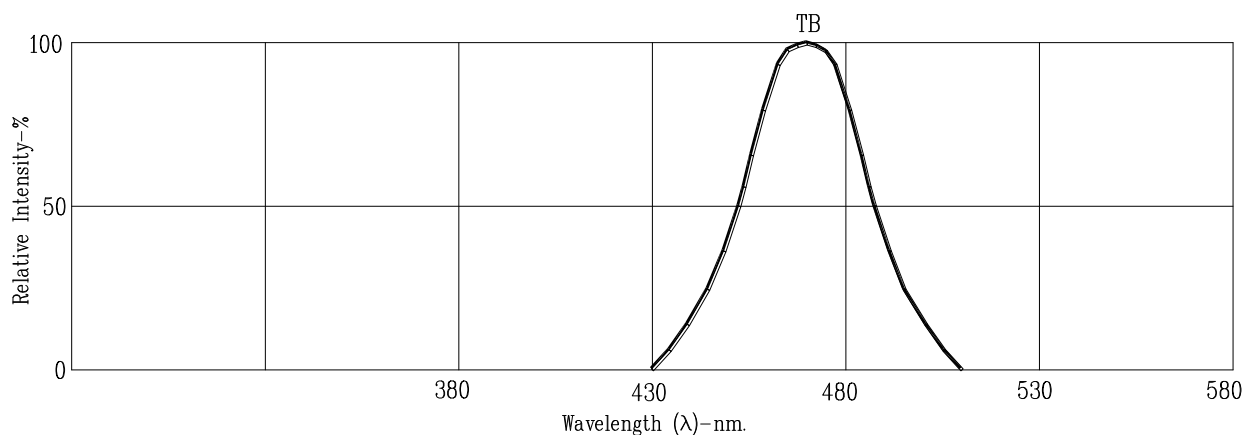


Fig1. RELATIVE INTENSITY VS. WAVELENGTH

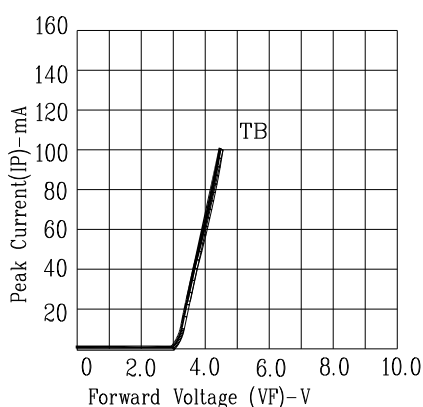


Fig3. FORWARD CURRENT VS. FORWARD VOLTAGE

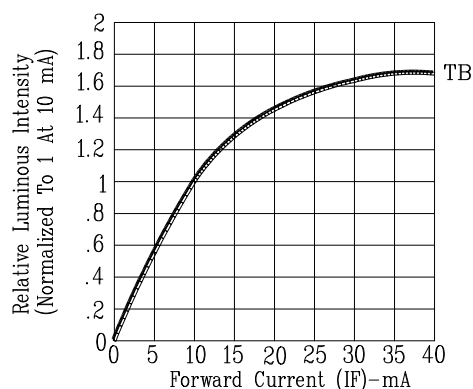


Fig4. RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

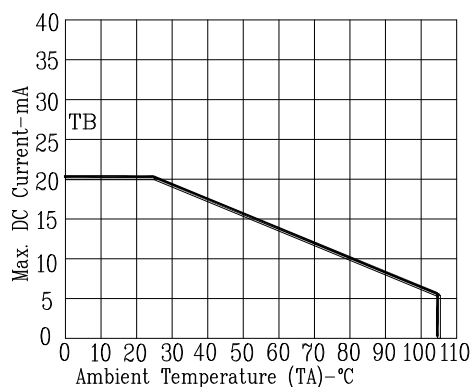


Fig5. MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE.

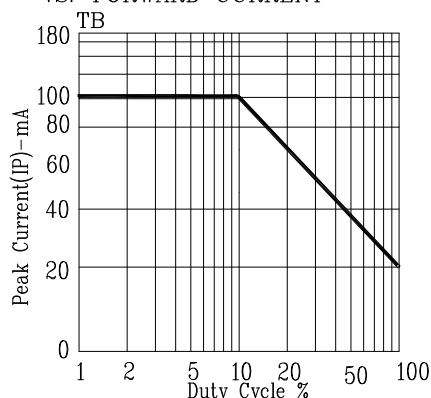
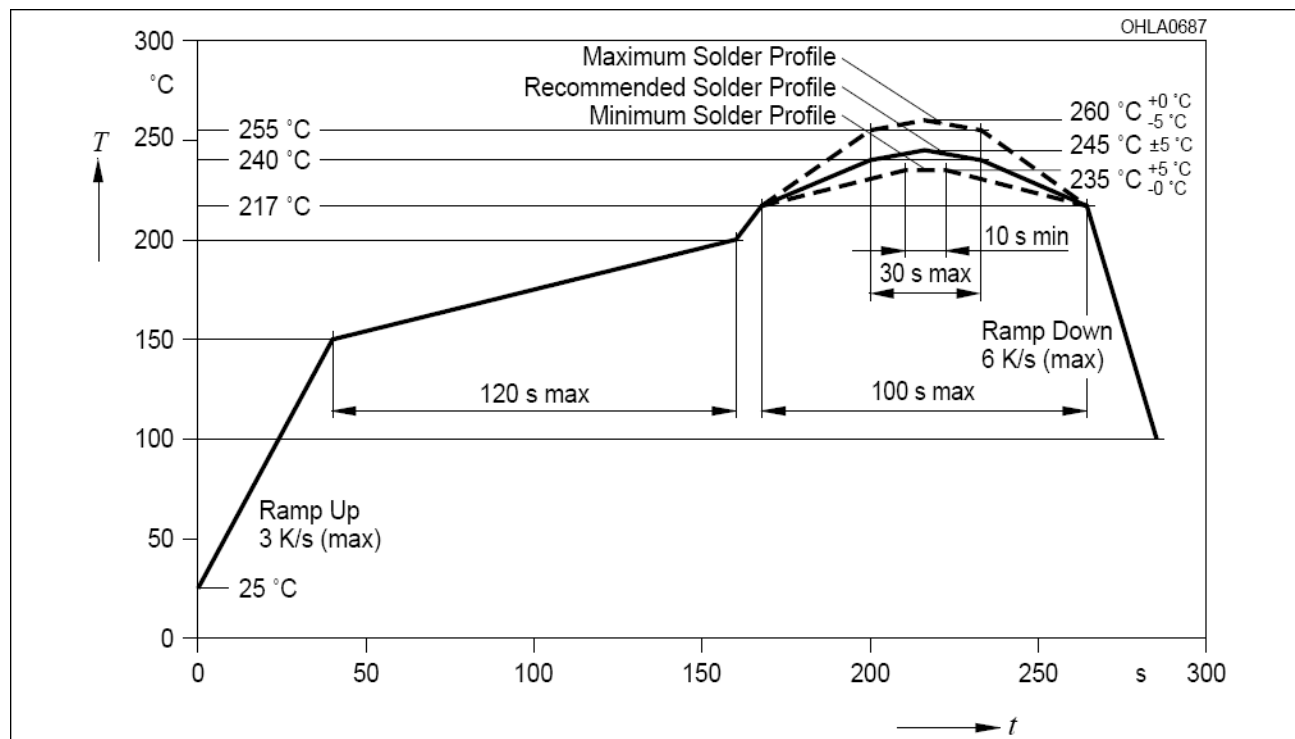


Fig6. MAX. PEAK CURRENT VS. DUTY CYCLE %
(REFRESH RATE 1KHz)

NOTE: TB=InGaN/sapphire Blue

SMT SOLDERING INSTRUCTION



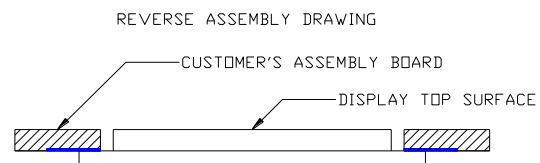
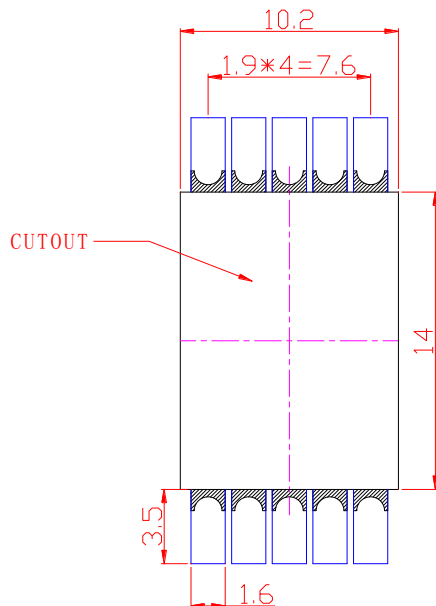
Note:

1. Recommended soldering condition:

Reflow Soldering (Two times only)		Soldering Iron (One time only)	
Pre-heat:	120~150°C.	Temperature	300°C Max.
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.
Peak temperature:	260°C Max.		
Soldering time:	5sec. Max.		

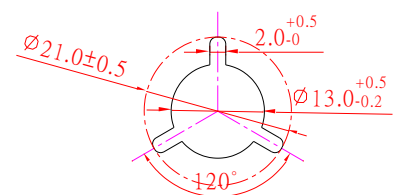
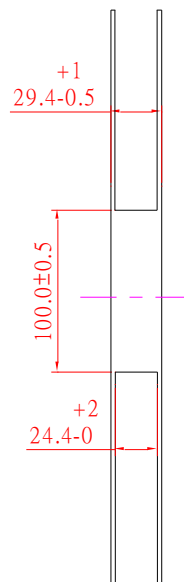
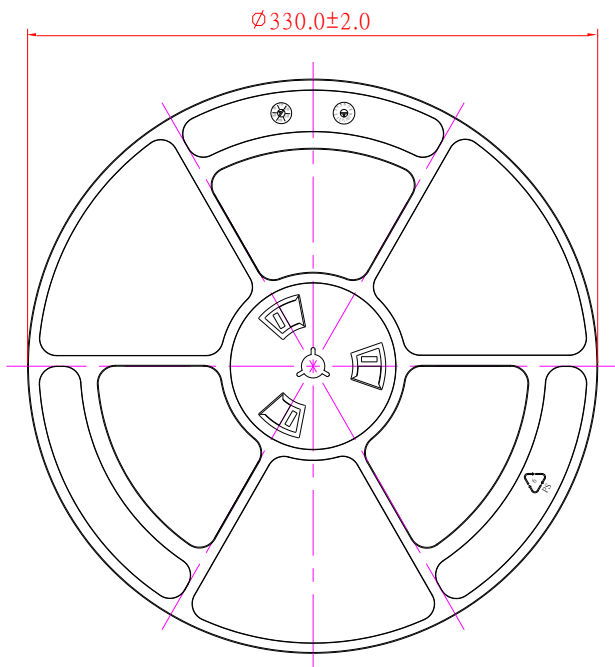
2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

RECOMMENDED SOLDERING PATTERN



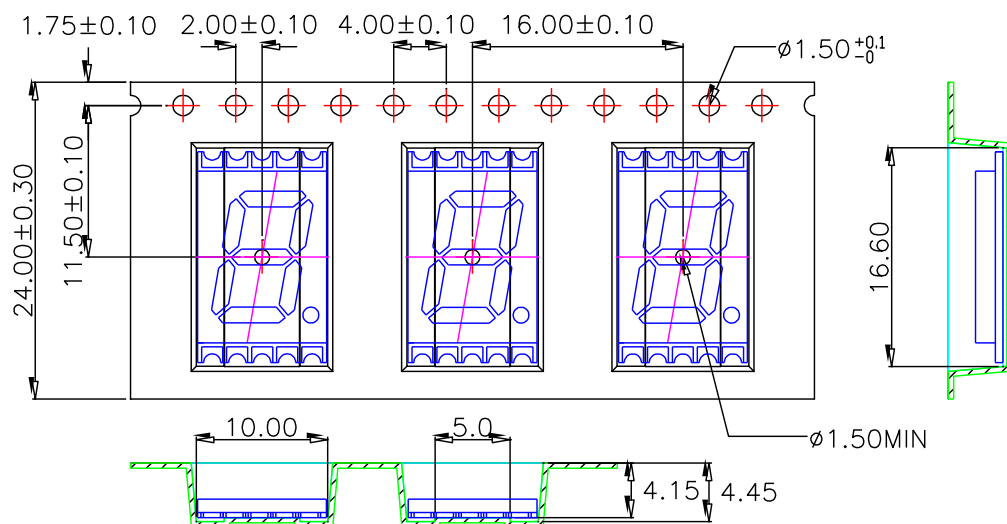
Note: All dimensions are in millimeters.

PACKING REEL DIMENSIONS



PACKING CARRIER DIMENSIONS

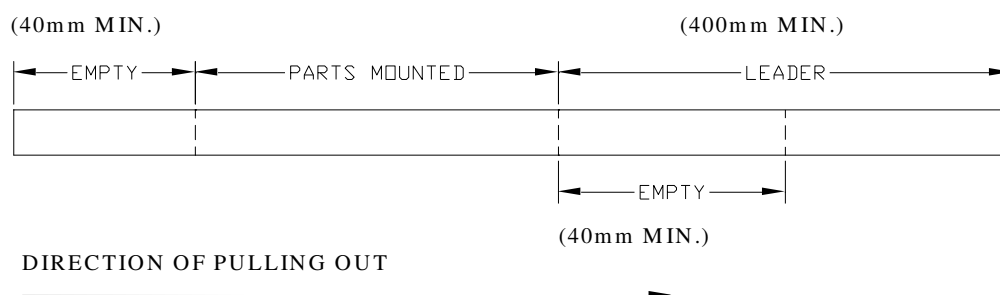
1. Taping parts:



1. 10 sprocket hole pitch cumulative tolerance ±0.20.
2. Carrier camber is within 1 mm in 250 mm.
3. All dimensions meet EIA-481-C requirements.
4. Thickness : 0.40±0.05mm.
5. Packing length per 22" reel : 45.50 Meters.
6. Component load per 13" reel : 800 pcs.

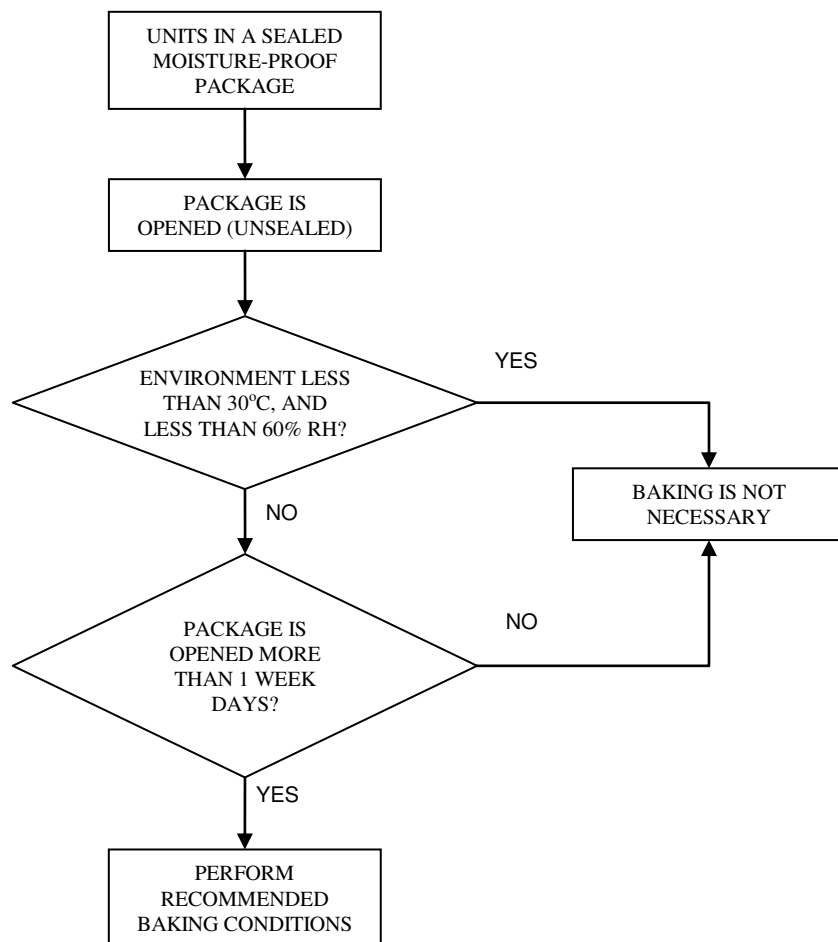
W	24.00±0.30
A0	10.00±0.10
A1	9.80±0.10
B0	16.60±0.10
B1	16.45±0.10
K0	4.45±0.10
K1	4.15±0.10

2. Trailer part/ Leader part:



Moisture Proof Packaging

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 90% RH or less. Once the package opened, moisture absorption begins.



Baking Conditions

If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60 °C	≥ 48hours
In Bulk	100 °C	≥ 4hours
	125 °C	≥ 2hours

Baking should only be done once.